AMD Xilinx - XC2V1000-4FGG256I Datasheet

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Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	1280
Number of Logic Elements/Cells	-
Total RAM Bits	737280
Number of I/O	172
Number of Gates	1000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v1000-4fgg256i

Table 5: **Summary of Voltage Supply Requirements for All Input and Output Standards**

I/O Standard	V_{CCO}		V_{REF}	Termination Type	
	Output	Input	Input	Output	Input
LVDS_33	3.3	N/R	N/R[1]	N/R	N/R
LVDSEXT_33			N/R	N/R	N/R
LVPECL_33			N/R	N/R	N/R
SSTL3_I			1.5	N/R	N/R
SSTL3_II			1.5	N/R	N/R
AGP			1.32	N/R	N/R
LVTTL		3.3	N/R	N/R	N/R
LVCMOS33			N/R	N/R	N/R
LVDCI_33			N/R	Series	N/R
LVDCI_DV2_33			N/R	Series	N/R
PCI33_3			N/R	N/R	N/R
PCI66_3			N/R	N/R	N/R
PCIX			N/R	N/R	N/R
SSTL3_I_DCI			1.5	N/R	Split
SSTL3_II_DCI			1.5	Split	Split
LVDS_25	2.5	N/R	N/R	N/R	N/R
LVDSEXT_25			N/R	N/R	N/R
LDT_25			N/R	N/R	N/R
ULVDS_25			N/R	N/R	N/R
BLVDS_25			N/R	N/R	N/R
SSTL2_I			1.25	N/R	N/R
SSTL2_II			1.25	N/R	N/R
LVCMOS25		2.5	N/R	N/R	N/R
LVDCI_25			N/R	Series	N/R
LVDCI_DV2_25			N/R	Series	N/R
LVDS_25_DCI			N/R	N/R	Split
LVDSEXT_25_DCI			N/R	N/R	Split
SSTL2_I_DCI			1.25	N/R	Split
SSTL2_II_DCI			1.25	Split	Split

Table 5: **Summary of Voltage Supply Requirements for All Input and Output Standards *(Continued)***

I/O Standard	V_{CCO}		V_{REF}	Termination Type	
	Output	Input	Input	Output	Input
HSTL_III_18	1.8	N/R	1.1	N/R	N/R
HSTL_IV_18			1.1	N/R	N/R
HSTL_I_18			0.9	N/R	N/R
HSTL_II_18			0.9	N/R	N/R
SSTL18_I			0.9	N/R	N/R
SSTL18_II			0.9	N/R	N/R
LVCMOS18		1.8	N/R	N/R	N/R
LVDCI_18			N/R	Series	N/R
LVDCI_DV2_18			N/R	Series	N/R
HSTL_III_DCI_18			1.1	N/R	Single
HSTL_IV_DCI_18			1.1	Single	Single
HSTL_I_DCI_18			0.9	N/R	Split
HSTL_II_DCI_18			0.9	Split	Split
SSTL18_I_DCI			0.9	N/R	Split
SSTL18_II_DCI			0.9	Split	Split
HSTL_III	1.5	N/R	0.9	N/R	N/R
HSTL_IV			0.9	N/R	N/R
HSTL_I			0.75	N/R	N/R
HSTL_II			0.75	N/R	N/R
LVCMOS15		1.5	N/R	N/R	N/R
LVDCI_15			N/R	Series	N/R
LVDCI_DV2_15			N/R	Series	N/R
GTLP_DCI			1	Single	Single
HSTL_III_DCI			0.9	N/R	Single
HSTL_IV_DCI			0.9	Single	Single
HSTL_I_DCI			0.75	N/R	Split
HSTL_II_DCI			0.75	Split	Split
GTL_DCI	1.2	1.2	0.8	Single	Single
GTLP	N/R	N/R	1	N/R	N/R
GTL			0.8	N/R	N/R

Notes:
1. N/R = no requirement.

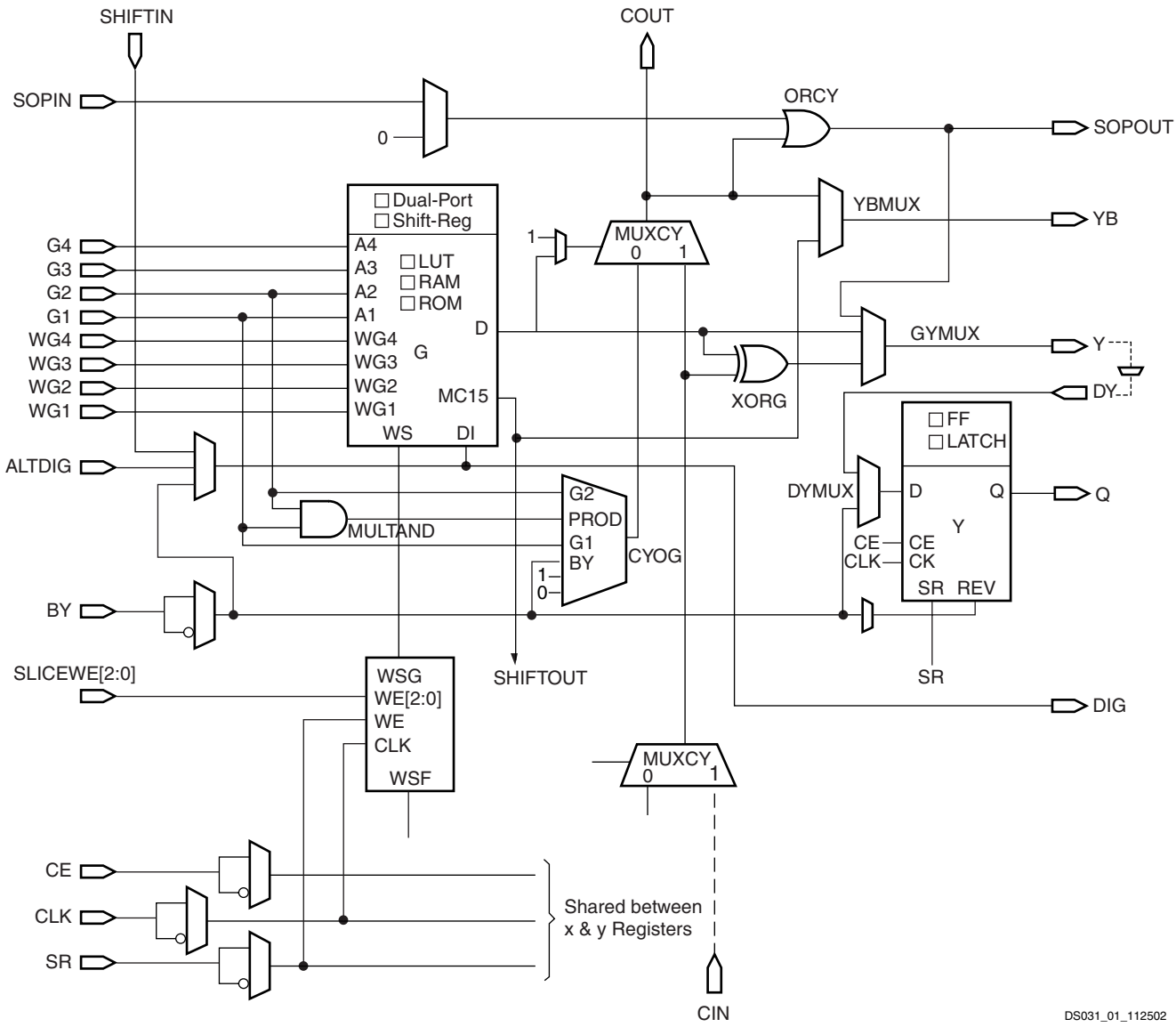

Figure 16: **Virtex-II Slice (Top Half)**

Table 4: **Quiescent Supply Current**

Symbol	Description	Device	Min	Typical	Max	Units
I_{CCINTQ}	Quiescent V_{CCINT} supply current	XC2V40		3	125	mA
		XC2V80		5	125	
		XC2V250		8	150	
		XC2V500		10	200	
		XC2V1000		12	250	
		XC2V1500		15	350	
		XC2V2000		20	400	
		XC2V3000		27	500	
		XC2V4000		35	650	
		XC2V6000		45	800	
		XC2V8000		60	1100	
I_{CCOQ}	Quiescent V_{CCO} supply current(1,2)	XC2V40		1	2	mA
		XC2V80		1	2	
		XC2V250		1	2	
		XC2V500		1	2	
		XC2V1000		1	2	
		XC2V1500		2	4	
		XC2V2000		2	4	
		XC2V3000		2	4	
		XC2V4000		2	4	
		XC2V6000		2	4	
		XC2V8000		2	4	
I_{CCAUXQ}	Quiescent V_{CCAUX} supply current(1,2)	XC2V40		5	25	mA
		XC2V80		5	25	
		XC2V250		5	25	
		XC2V500		5	25	
		XC2V1000		5	25	
		XC2V1500		7.5	50	
		XC2V2000		7.5	50	
		XC2V3000		10	75	
		XC2V4000		10	75	
		XC2V6000		12.5	100	
		XC2V8000		12.5	100	

Notes:
1. With no output current loads, no active input pull-up resistors, all I/O pins are 3-state and floating.
2. If DCI or differential signaling is used, more accurate values can be obtained by using the Power Estimator or XPOWER™.
3. Data are retained even if V_{CCO} drops to 0 V.
4. Values specified for quiescent supply current parameters are Commercial Grade. For Industrial Grade values, multiply Commercial Grade values by 1.25.

Power-On Power Supply Requirements

Xilinx FPGAs require a certain amount of supply current during power-on to insure proper device operation. The actual current consumed depends on the power-on ramp rate of the power supply.

The V_{CCINT}, V_{CCAUX}, and V_{CCO} power supplies shall each ramp on, monotonically, no faster than 200 µs and no slower than 50 ms. Ramp on is defined as: 0 V_{DC} to minimum supply voltages.

Table 5 shows the minimum current required by Virtex-II devices for proper power on and configuration.

Power supplies can be turned on in any sequence.(1)

If any V_{CCO} bank powers up before V_{CCAUX}, then each bank draws up to 300 mA, worst case, until the V_{CCAUX} powers up.(2) This does not harm the device. If the current is limited to the minimum value above, or larger, the device powers on properly after all three supplies have passed through their power-on reset threshold voltages.

Once initialized and configured, use the power calculator to estimate current drain on these supplies.

Notes:
1. If the V_{CCINT} ramp rate is longer than 10 ms, then V_{CCINT} must be applied before V_{CCO} and V_{CCAUX}. The device will not be damaged if this requirement is violated, but configuration will probably fail.
2. The 300 mA is transient current (peak); it eventually disappears even if V_{CCAUX} does not power up.

Table 27: **Enhanced Pipelined Multiplier Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Setup and Hold Times Before/After Clock					
Data Inputs	$T_{MULIDCK}/T_{MULCKID}$	3.00/0.00	3.45/0.00	3.89/0.00	ns, Max
Clock Enable	$T_{MULIDCK\_CE}/T_{MULCKID\_CE}$	0.72/0.00	0.80/0.00	0.86/0.00	ns, Max
Reset	$T_{MULIDCK\_RST}/T_{MULCKID\_RST}$	0.72/0.00	0.80/0.00	0.86/0.00	ns, Max
Clock to Output Pin					
Clock to Pin 35	$T_{MULTCK1\_P35}$	3.05	3.25	3.74	ns, Max
Clock to Pin 34	$T_{MULTCK1\_P34}$	2.95	3.14	3.61	ns, Max
Clock to Pin 33	$T_{MULTCK1\_P33}$	2.85	3.04	3.49	ns, Max
Clock to Pin 32	$T_{MULTCK1\_P32}$	2.76	2.93	3.37	ns, Max
Clock to Pin 31	$T_{MULTCK1\_P31}$	2.66	2.82	3.25	ns, Max
Clock to Pin 30	$T_{MULTCK1\_P30}$	2.56	2.72	3.12	ns, Max
Clock to Pin 29	$T_{MULTCK1\_P29}$	2.47	2.61	3.00	ns, Max
Clock to Pin 28	$T_{MULTCK1\_P28}$	2.37	2.50	2.88	ns, Max
Clock to Pin 27	$T_{MULTCK1\_P27}$	2.27	2.40	2.75	ns, Max
Clock to Pin 26	$T_{MULTCK1\_P26}$	2.17	2.29	2.63	ns, Max
Clock to Pin 25	$T_{MULTCK1\_P25}$	2.08	2.18	2.51	ns, Max
Clock to Pin 24	$T_{MULTCK1\_P24}$	1.98	2.07	2.38	ns, Max
Clock to Pin 23	$T_{MULTCK1\_P23}$	1.88	1.97	2.26	ns, Max
Clock to Pin 22	$T_{MULTCK1\_P22}$	1.79	1.86	2.14	ns, Max
Clock to Pin 21	$T_{MULTCK1\_P21}$	1.69	1.75	2.02	ns, Max
Clock to Pin 20	$T_{MULTCK1\_P20}$	1.59	1.65	1.89	ns, Max
Clock to Pin 19	$T_{MULTCK1\_P19}$	1.50	1.54	1.77	ns, Max
Clock to Pin 18	$T_{MULTCK1\_P18}$	1.40	1.43	1.65	ns, Max
Clock to Pin 17	$T_{MULTCK1\_P17}$	1.30	1.33	1.52	ns, Max
Clock to Pin 16	$T_{MULTCK1\_P16}$	1.20	1.22	1.40	ns, Max
Clock to Pin 15	$T_{MULTCK1\_P15}$	1.11	1.11	1.28	ns, Max
Clock to Pin 14	$T_{MULTCK1\_P14}$	1.01	1.00	1.15	ns, Max
Clock to Pin 13	$T_{MULTCK1\_P13}$	0.91	1.00	1.15	ns, Max
Clock to Pin 12	$T_{MULTCK1\_P12}$	0.91	1.00	1.15	ns, Max
Clock to Pin 11	$T_{MULTCK1\_P11}$	0.91	1.00	1.15	ns, Max
Clock to Pin 10	$T_{MULTCK1\_P10}$	0.91	1.00	1.15	ns, Max
Clock to Pin 9	$T_{MULTCK1\_P9}$	0.91	1.00	1.15	ns, Max
Clock to Pin 8	$T_{MULTCK1\_P8}$	0.91	1.00	1.15	ns, Max
Clock to Pin 7	$T_{MULTCK1\_P7}$	0.91	1.00	1.15	ns, Max
Clock to Pin 6	$T_{MULTCK1\_P6}$	0.91	1.00	1.15	ns, Max
Clock to Pin 5	$T_{MULTCK1\_P5}$	0.91	1.00	1.15	ns, Max
Clock to Pin 4	$T_{MULTCK1\_P4}$	0.91	1.00	1.15	ns, Max
Clock to Pin 3	$T_{MULTCK1\_P3}$	0.91	1.00	1.15	ns, Max
Clock to Pin 2	$T_{MULTCK1\_P2}$	0.91	1.00	1.15	ns, Max
Clock to Pin 1	$T_{MULTCK1\_P1}$	0.91	1.00	1.15	ns, Max
Clock to Pin 0	$T_{MULTCK1\_P0}$	0.91	1.00	1.15	ns, Max

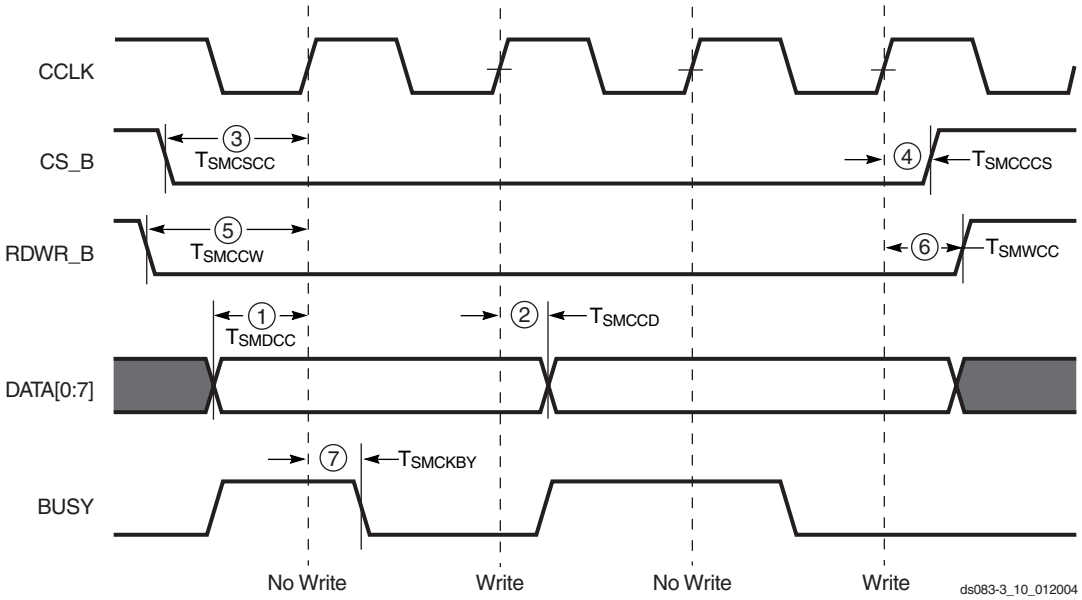

Figure 5: **SelectMAP Mode Data Loading Sequence (Generic)**

Table 32: **SelectMAP Mode Write Timing Characteristics**

	Description	Figure References	Symbol	Value	Units
CCLK	DATA[0:7] setup/hold	1/2	T_{SMDCC}/T_{SMCCD}	5.0/0.0	ns, min
	CS_B setup/hold	3/4	T_{SMCSCC}/T_{SMCCCS}	7.0/0.0	ns, min
	RDWR_B setup/hold	5/6	T_{SMCCW}/T_{SMWCC}	7.0/0.0	ns, min
	BUSY propagation delay	7	T_{SMCKBY}	12.0	ns, max
	Maximum start-up frequency		$F_{CC\_STARTUP}$	50	MHz, max
	Maximum frequency		$F_{CC\_SELECTMAP}$	50	MHz, max
	Maximum frequency with no handshake		F_{CCNH}	50	MHz, max

Table 6: **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
7	IO_L45N_7	F5	NC	NC
7	IO_L43P_7	F1	NC	NC
7	IO_L43N_7	F2	NC	NC
7	IO_L06P_7	F3	NC	
7	IO_L06N_7	F4	NC	
7	IO_L04P_7	E1	NC	
7	IO_L04N_7	E2	NC	
7	IO_L03P_7/VREF_7	E3		
7	IO_L03N_7	E4		
7	IO_L02P_7/VRN_7	D2		
7	IO_L02N_7/VRP_7	D3		
7	IO_L01P_7	D1		
7	IO_L01N_7	C1		
0	VCCO_0	F8		
0	VCCO_0	F7		
0	VCCO_0	E8		
1	VCCO_1	F10		
1	VCCO_1	F9		
1	VCCO_1	E9		
2	VCCO_2	H12		
2	VCCO_2	H11		
2	VCCO_2	G11		
3	VCCO_3	K11		
3	VCCO_3	J12		
3	VCCO_3	J11		
4	VCCO_4	M9		
4	VCCO_4	L10		
4	VCCO_4	L9		
5	VCCO_5	M8		
5	VCCO_5	L8		
5	VCCO_5	L7		
6	VCCO_6	K6		
6	VCCO_6	J6		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
1	IO_L92P_1	A15		
1	IO_L91N_1	B15		
1	IO_L91P_1/VREF_1	C15		
1	IO_L78N_1	D15	NC	
1	IO_L78P_1	E15	NC	
1	IO_L76N_1	F15	NC	
1	IO_L76P_1	G15	NC	
1	IO_L75N_1/VREF_1	G16	NC	
1	IO_L75P_1	F16	NC	
1	IO_L73N_1	A16	NC	
1	IO_L73P_1	A17	NC	
1	IO_L72N_1	B16		
1	IO_L72P_1	C16		
1	IO_L70N_1	D16		
1	IO_L70P_1	E16		
1	IO_L69N_1/VREF_1	C17		
1	IO_L69P_1	D17		
1	IO_L67N_1	H16		
1	IO_L67P_1	G17		
1	IO_L54N_1	E17		
1	IO_L54P_1	F17		
1	IO_L52N_1	A18		
1	IO_L52P_1	A19		
1	IO_L51N_1/VREF_1	E18		
1	IO_L51P_1	D18		
1	IO_L49N_1	B18		
1	IO_L49P_1	C18		
1	IO_L27N_1/VREF_1	F19	NC	NC
1	IO_L27P_1	F18	NC	NC
1	IO_L25N_1	G18	NC	NC
1	IO_L25P_1	G19	NC	NC
1	IO_L24N_1	B19		
1	IO_L24P_1	C19		
1	IO_L22N_1	D19		
1	IO_L22P_1	E19		
1	IO_L21N_1/VREF_1	A20		
1	IO_L21P_1	A21		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
2	IO_L45N_2	H23		
2	IO_L45P_2/VREF_2	H24		
2	IO_L46N_2	J21		
2	IO_L46P_2	J20		
2	IO_L48N_2	H25		
2	IO_L48P_2	H26		
2	IO_L49N_2	J22		
2	IO_L49P_2	J23		
2	IO_L51N_2	K21		
2	IO_L51P_2/VREF_2	K22		
2	IO_L52N_2	K20		
2	IO_L52P_2	L20		
2	IO_L54N_2	J24		
2	IO_L54P_2	J25		
2	IO_L67N_2	K23		
2	IO_L67P_2	K24		
2	IO_L69N_2	J26		
2	IO_L69P_2/VREF_2	K26		
2	IO_L70N_2	L22		
2	IO_L70P_2	L21		
2	IO_L72N_2	L25		
2	IO_L72P_2	L26		
2	IO_L73N_2	L19	NC	
2	IO_L73P_2	M19	NC	
2	IO_L75N_2	L23	NC	
2	IO_L75P_2/VREF_2	L24	NC	
2	IO_L76N_2	M22	NC	
2	IO_L76P_2	M21	NC	
2	IO_L78N_2	M23	NC	
2	IO_L78P_2	M24	NC	
2	IO_L91N_2	M25		
2	IO_L91P_2	M26		
2	IO_L93N_2	M20		
2	IO_L93P_2/VREF_2	N20		
2	IO_L94N_2	N22		
2	IO_L94P_2	N21		
2	IO_L96N_2	N24		

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
6	IO_L06N_6	V6		
6	IO_L19P_6	U7		
6	IO_L19N_6	T8		
6	IO_L21P_6	AA1		
6	IO_L21N_6/VREF_6	Y2		
6	IO_L22P_6	Y1		
6	IO_L22N_6	W1		
6	IO_L24P_6	W2		
6	IO_L24N_6	V2		
6	IO_L43P_6	V4		
6	IO_L43N_6	V3		
6	IO_L45P_6	U6		
6	IO_L45N_6/VREF_6	U5		
6	IO_L46P_6	T7		
6	IO_L46N_6	T6		
6	IO_L48P_6	R8		
6	IO_L48N_6	R7		
6	IO_L49P_6	U2		
6	IO_L49N_6	U1		
6	IO_L51P_6	U4		
6	IO_L51N_6/VREF_6	U3		
6	IO_L52P_6	T1		
6	IO_L52N_6	R1		
6	IO_L54P_6	T3		
6	IO_L54N_6	T2		
6	IO_L67P_6	T5	NC	
6	IO_L67N_6	T4	NC	
6	IO_L69P_6	R6	NC	
6	IO_L69N_6/VREF_6	R5	NC	
6	IO_L70P_6	P8	NC	
6	IO_L70N_6	P7	NC	
6	IO_L72P_6	R2	NC	
6	IO_L72N_6	P1	NC	
6	IO_L73P_6	R3	NC	NC
6	IO_L73N_6	P3	NC	NC
6	IO_L91P_6	P5		

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
NA	GND	D15		
NA	GND	D10		
NA	GND	D4		
NA	GND	C22		
NA	GND	C3		
NA	GND	B24		
NA	GND	B23		
NA	GND	B2		
NA	GND	B1		
NA	GND	A24		
NA	GND	A23		
NA	GND	A18		
NA	GND	A7		
NA	GND	A2		

Notes:
1. See Table 4 for an explanation of the signals available on this pin.

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
1	IO_L27N_1/VREF_1	F19
1	IO_L27P_1	G19
1	IO_L25N_1	J19
1	IO_L25P_1	J20
1	IO_L24N_1	C20
1	IO_L24P_1	C21
1	IO_L22N_1	D20
1	IO_L22P_1	E21
1	IO_L21N_1/VREF_1	E20
1	IO_L21P_1	F20
1	IO_L19N_1	A21
1	IO_L19P_1	B21
1	IO_L06N_1	A22
1	IO_L06P_1	B22
1	IO_L05N_1	C22
1	IO_L05P_1	C23
1	IO_L04N_1	D22
1	IO_L04P_1/VREF_1	E22
1	IO_L03N_1/VRP_1	A23
1	IO_L03P_1/VRN_1	B23
1	IO_L02N_1	A24
1	IO_L02P_1	B24
1	IO_L01N_1	A25
1	IO_L01P_1	B25
2	IO_L01N_2	C27
2	IO_L01P_2	D27
2	IO_L02N_2/VRP_2	D25
2	IO_L02P_2/VRN_2	D26
2	IO_L03N_2	E24
2	IO_L03P_2/VREF_2	E25
2	IO_L04N_2	E26
2	IO_L04P_2	E27
2	IO_L06N_2	F23
2	IO_L06P_2	F24
2	IO_L19N_2	F25

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
5	IO_L52N_5	AC10
5	IO_L52P_5	AB10
5	IO_L51N_5/VREF_5	Y9
5	IO_L51P_5	Y10
5	IO_L49N_5	AG9
5	IO_L49P_5	AG8
5	IO_L30N_5	AF9
5	IO_L30P_5	AE9
5	IO_L28N_5	AD9
5	IO_L28P_5	AC9
5	IO_L27N_5/VREF_5	AB9
5	IO_L27P_5	AA9
5	IO_L25N_5	AE8
5	IO_L25P_5	AE7
5	IO_L24N_5	AD8
5	IO_L24P_5	AC8
5	IO_L22N_5	AB8
5	IO_L22P_5	AA8
5	IO_L21N_5/VREF_5	AG7
5	IO_L21P_5	AF7
5	IO_L19N_5	AC7
5	IO_L19P_5	AB7
5	IO_L06N_5	AG6
5	IO_L06P_5	AF6
5	IO_L05N_5/VRP_5	AE6
5	IO_L05P_5/VRN_5	AD6
5	IO_L04N_5	AG5
5	IO_L04P_5/VREF_5	AF5
5	IO_L03N_5/D4/ALT_VRP_5	AE5
5	IO_L03P_5/D5/ALT_VRN_5	AD5
5	IO_L02N_5/D6	AG4
5	IO_L02P_5/D7	AF4
5	IO_L01N_5/RDWR_B	AG3
5	IO_L01P_5/CS_B	AF3
6	IO_L01P_6	AE1

FF896 Flip-Chip Fine-Pitch BGA Package

As shown in Table 11, XC2V1000, XC2V1500, and XC2V2000 Virtex-II devices are available in the FF896 flip-chip fine-pitch BGA package. Pins in the XC2V1000, XC2V1500, and XC2V2000 devices are the same, except for the pin differences in the XC2V1000 and XC2V1500 devices shown in the No Connect columns. Following this table are the FF896 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
0	IO_L01N_0	B27		
0	IO_L01P_0	A27		
0	IO_L02N_0	F24		
0	IO_L02P_0	E24		
0	IO_L03N_0/VRP_0	C26		
0	IO_L03P_0/VRN_0	C25		
0	IO_L04N_0/VREF_0	A26		
0	IO_L04P_0	A25		
0	IO_L05N_0	F23		
0	IO_L05P_0	F22		
0	IO_L06N_0	C24		
0	IO_L06P_0	D25		
0	IO_L19N_0	A24		
0	IO_L19P_0	B25		
0	IO_L20N_0	G22		
0	IO_L20P_0	G21		
0	IO_L21N_0	D24		
0	IO_L21P_0/VREF_0	D23		
0	IO_L22N_0	B23		
0	IO_L22P_0	B24		
0	IO_L23N_0	H21		
0	IO_L23P_0	H20		
0	IO_L24N_0	E22		
0	IO_L24P_0	E23		
0	IO_L49N_0	A22		
0	IO_L49P_0	B22		
0	IO_L50N_0	F21		
0	IO_L50P_0	F20		
0	IO_L51N_0	C23		
0	IO_L51P_0/VREF_0	C22		
0	IO_L52N_0	B20		
0	IO_L52P_0	B21		

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
1	IO_L68P_1	G12	NC	
1	IO_L67N_1	A9	NC	
1	IO_L67P_1	A10	NC	
1	IO_L54N_1	E10		
1	IO_L54P_1	E11		
1	IO_L53N_1	H12		
1	IO_L53P_1	H11		
1	IO_L52N_1	D9		
1	IO_L52P_1	D10		
1	IO_L51N_1/VREF_1	C9		
1	IO_L51P_1	C8		
1	IO_L50N_1	F11		
1	IO_L50P_1	F10		
1	IO_L49N_1	B8		
1	IO_L49P_1	B9		
1	IO_L24N_1	E8		
1	IO_L24P_1	E9		
1	IO_L23N_1	G11		
1	IO_L23P_1	H10		
1	IO_L22N_1	B7		
1	IO_L22P_1	A7		
1	IO_L21N_1/VREF_1	D8		
1	IO_L21P_1	E7		
1	IO_L20N_1	G10		
1	IO_L20P_1	G9		
1	IO_L19N_1	A5		
1	IO_L19P_1	A6		
1	IO_L06N_1	C6		
1	IO_L06P_1	C7		
1	IO_L05N_1	F9		
1	IO_L05P_1	G8		
1	IO_L04N_1	B6		
1	IO_L04P_1/VREF_1	C5		
1	IO_L03N_1/VRP_1	D7		
1	IO_L03P_1/VRN_1	D6		
1	IO_L02N_1	F8		
1	IO_L02P_1	F7		

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
4	IO_L19N_4	AK6		
4	IO_L19P_4	AK5		
4	IO_L20N_4	AE9		
4	IO_L20P_4	AE10		
4	IO_L21N_4	AF7		
4	IO_L21P_4/VREF_4	AF8		
4	IO_L22N_4	AK7		
4	IO_L22P_4	AJ6		
4	IO_L23N_4	AD10		
4	IO_L23P_4	AD11		
4	IO_L24N_4	AG8		
4	IO_L24P_4	AG7		
4	IO_L49N_4	AJ8		
4	IO_L49P_4	AJ7		
4	IO_L50N_4	AE11		
4	IO_L50P_4	AE12		
4	IO_L51N_4	AG9		
4	IO_L51P_4/VREF_4	AG10		
4	IO_L52N_4	AK9		
4	IO_L52P_4	AJ9		
4	IO_L53N_4	AH8		
4	IO_L53P_4	AH9		
4	IO_L54N_4	AF11		
4	IO_L54P_4	AF10		
4	IO_L67N_4	AJ11	NC	
4	IO_L67P_4	AJ10	NC	
4	IO_L68N_4	AC12	NC	
4	IO_L68P_4	AC13	NC	
4	IO_L69N_4	AG11	NC	
4	IO_L69P_4/VREF_4	AG12	NC	
4	IO_L70N_4	AK11	NC	
4	IO_L70P_4	AK10	NC	
4	IO_L71N_4	AD12	NC	
4	IO_L71P_4	AD13	NC	
4	IO_L72N_4	AH12	NC	
4	IO_L72P_4	AH11	NC	
4	IO_L73N_4	AJ13	NC	NC

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L69N_1/VREF_1	E15		
1	IO_L69P_1	E16		
1	IO_L68N_1	K17		
1	IO_L68P_1	K16		
1	IO_L67N_1	C15		
1	IO_L67P_1	B15		
1	IO_L60N_1	F15		
1	IO_L60P_1	F16		
1	IO_L59N_1	H16		
1	IO_L59P_1	H15		
1	IO_L58N_1	C13		
1	IO_L58P_1	C14		
1	IO_L57N_1/VREF_1	D13		
1	IO_L57P_1	D14		
1	IO_L56N_1	M17		
1	IO_L56P_1	M16		
1	IO_L55N_1	A12		
1	IO_L55P_1	A13		
1	IO_L54N_1	B12		
1	IO_L54P_1	B13		
1	IO_L53N_1	G15		
1	IO_L53P_1	G14		
1	IO_L52N_1	C11		
1	IO_L52P_1	C12		
1	IO_L51N_1/VREF_1	F13		
1	IO_L51P_1	F14		
1	IO_L50N_1	L16		
1	IO_L50P_1	L15		
1	IO_L49N_1	A10		
1	IO_L49P_1	A11		
1	IO_L36N_1	E12	NC	
1	IO_L36P_1	E13	NC	
1	IO_L35N_1	K15	NC	
1	IO_L35P_1	J14	NC	
1	IO_L34N_1	B9	NC	
1	IO_L34P_1	B10	NC	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
3	IO_L10N_3	AK7	NC	
3	IO_L10P_3	AL7	NC	
3	IO_L09N_3/VREF_3	AK11	NC	
3	IO_L09P_3	AJ10	NC	
3	IO_L08N_3	AR1	NC	
3	IO_L08P_3	AT1	NC	
3	IO_L07N_3	AM5	NC	
3	IO_L07P_3	AN5	NC	
3	IO_L06N_3	AM7		
3	IO_L06P_3	AL8		
3	IO_L05N_3	AP3		
3	IO_L05P_3	AP4		
3	IO_L04N_3	AM6		
3	IO_L04P_3	AN6		
3	IO_L03N_3/VREF_3	AJ13		
3	IO_L03P_3	AH13		
3	IO_L02N_3/VRP_3	AR3		
3	IO_L02P_3/VRN_3	AT2		
3	IO_L01N_3	AP5		
3	IO_L01P_3	AR4		
4	IO_L01N_4/BUSY/DOUT(1)	AV4		
4	IO_L01P_4/INIT_B	AU4		
4	IO_L02N_4/D0/DIN(1)	AM9		
4	IO_L02P_4/D1	AM10		
4	IO_L03N_4/D2/ALT_VRP_4	AT6		
4	IO_L03P_4/D3/ALT_VRN_4	AR6		
4	IO_L04N_4/VREF_4	AU6		
4	IO_L04P_4	AU5		
4	IO_L05N_4/VRP_4	AL10		
4	IO_L05P_4/VRN_4	AL11		
4	IO_L06N_4	AR8		
4	IO_L06P_4	AR7		
4	IO_L07N_4	AW5	NC	
4	IO_L07P_4	AW4	NC	
4	IO_L08N_4	AK12	NC	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	DXP	B28	
NA	VBATT	D5	
NA	RSVD	B4	
NA	VCCAUX	B16	
NA	VCCAUX	C2	
NA	VCCAUX	C30	
NA	VCCAUX	T2	
NA	VCCAUX	T30	
NA	VCCAUX	AJ2	
NA	VCCAUX	AJ30	
NA	VCCAUX	AK16	
NA	VCCINT	K15	
NA	VCCINT	K17	
NA	VCCINT	L11	
NA	VCCINT	L16	
NA	VCCINT	L21	
NA	VCCINT	M12	
NA	VCCINT	M16	
NA	VCCINT	M20	
NA	VCCINT	N13	
NA	VCCINT	N14	
NA	VCCINT	N15	
NA	VCCINT	N16	
NA	VCCINT	N17	
NA	VCCINT	N18	
NA	VCCINT	N19	
NA	VCCINT	P13	
NA	VCCINT	P19	
NA	VCCINT	R10	
NA	VCCINT	R13	
NA	VCCINT	R19	
NA	VCCINT	R22	
NA	VCCINT	T11	
NA	VCCINT	T12	
NA	VCCINT	T13	
NA	VCCINT	T19	
NA	VCCINT	T20	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	GND	AG27	
NA	GND	AH4	
NA	GND	AH10	
NA	GND	AH16	
NA	GND	AH22	
NA	GND	AH28	
NA	GND	AJ1	
NA	GND	AJ3	
NA	GND	AJ29	
NA	GND	AJ31	
NA	GND	AK1	
NA	GND	AK2	
NA	GND	AK8	
NA	GND	AK24	
NA	GND	AK30	
NA	GND	AK31	
NA	GND	AL2	
NA	GND	AL3	
NA	GND	AL16	
NA	GND	AL29	
NA	GND	AL30	

Notes:
1. See Table 4 for an explanation of the signals available on this pin.

Notice of Disclaimer

Virtex-II Data Sheet

The Virtex-II Data Sheet contains the following modules: